

DESCRIPTION

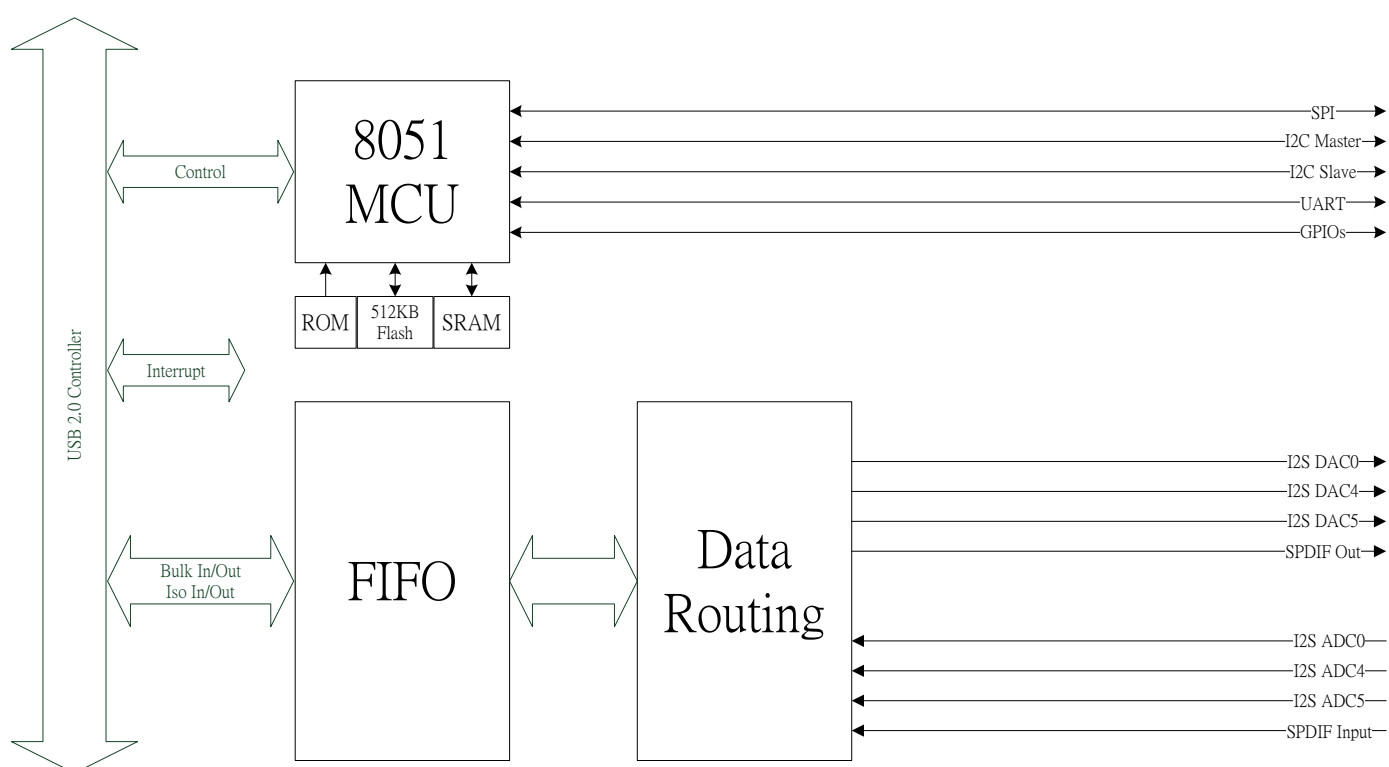
The CM6637 is a USB 2.0 high speed audio controller that complies with USB Audio Device Class 2.0. The CM6637 provides standard I2S and S/PDIF digital audio interface. The maximum outputs are 12 channels separate to I2S, TDM, HDA and S/PDIF. The maximum inputs are 12 channels as well and separate to I2S, TDM, HDA and S/PDIF. The first I2S out interface can be used to transfer PCM and DSD audio data. Moreover, the CM6637 supports I2C, SPI and GPIOs to communicate with external device.

The CM6637 is embedded with 8051 MCU and 512KB flash makes it is very flexible to change the USB topology or communicate with external device by changing internal flash code.

FEATURES

- Compliant with USB 2.0 high-speed
- Compliant with USB Audio Device Class 2.0/1.0
- Compliant with USB Human Interface Device (HID) Class 1.1
- Supports USB suspend/resume/reset functions
- Supports control, interrupt, bulk, and isochronous data transfers
- Input and output support I2S/TDM/HDA and SPDIF digital audio interfaces
- The first I2S output supports up to 768KHz/32bits PCM
- The first I2S supports both DoP and Native DSD
- DoP up to 11.2MHz, DSD256
- Native DSD up to 22.4MHz, DSD512
- 3 stereo I2S serial audio input interfaces
- The first I2S input supports up to 384KHz/32bits
- S/PDIF input and output up to 192KHz/24bits
- 1 I2C master, 1 I2C slave, 6 SPI master, 24 GPIOs

BLOCK DIAGRAM



Release notes

Revision	Date	Description
0.93	2018/10/12	- First release of preliminary technical information
0.94	2018/12/17	- Modify pin description
1.00	2020/09/21	- Formal Release
1.10	2021/07/21	- Modify 7.Electrical Characteristics - Modify pin description
1.20	2022/02/08	- Remove 8K/16K/32K/64KHz sample rate from I2S interface - Remove 64K sample rate from SPDIF interface
1.30	2025/07/02	- Modify Electrical Characteristics

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1 Description and Overview

The CM6637 is a USB 2.0 high speed audio controller that complies with USB Audio Device Class 2.0. The CM6637 provides standard I2S and S/PDIF digital audio interface. The maximum outputs are 12 channels with 10 channels I2S and 2 channels S/PDIF and the maximum inputs are 12 channels with 10 channels I2S and 2 channels S/PDIF. The first I2S interface can be used to transfer PCM and DSD audio data. Moreover, the CM6637 supports I2C, SPI and GPIOs to communicate with external device.

The CM6637 is embedded with 8051 MCU and 512KB flash makes it is very flexible to change the USB topology or communicate with external device by changing internal flash code.

2 Ordering Information

Product	Package Marking	Package Type	Transport Media
CM6637	CM6637	QFN-100(12x12mm)	Tray

3 Features

3.1 USB Compliance

- Compliant with USB 2.0 high-speed
- Compliant with USB Audio Device Class 2.0/1.0
- Compliant with USB Human Interface Device (HID) Class 1.1
- Supports USB suspend/resume/reset functions
- Supports control, interrupt, bulk, and isochronous data transfers
- USB audio is asynchronous synchronization to reduce clock jitter

3.2 Digital Audio I/O

- 2 stereo I2S serial audio and 1 S/PDIF output interfaces, refer below [Table 1](#) for each audio format support
- 2 stereo I2S serial audio and 1 S/PDIF input interfaces, refer below [Table 1](#) for each audio format support
- All the I2S in/out support master and slave

Table 1

Interface	Audio Format		Bit Depth
I2S DAC0	PCM	768K/705.6K/384K/352.8K/192K/ 176.4K/96K/88.2K/48K/44.1K Hz	16/24/32 bits
	DSD	DoP: 2.8/5.6/11.2MHz Native: 2.8/5.6/11.2/22.4MHz	
I2S DAC4	PCM	192K/ 176.4K/96K/88.2K/48K/44.1K Hz	16/24 bits
I2S DAC5	PCM	192K/ 176.4K/96K/88.2K/48K/44.1K Hz	16/24 bits
S/PDIF Out	PCM	192K/ 176.4K/96K/88.2K/48K/44.1K/32K	16/24 bits
		AC3, DTS Compressed audio data	
I2S ADC0	PCM	384K/352.8K/192K/ 176.4K/96K/88.2K/48K/44.1K Hz	16/24/32 bits
I2S ADC4	PCM	192K/ 176.4K/96K/88.2K/48K/44.1K Hz	16/24 bits

I2S ADC5	PCM	192K/ 176.4K/96K/88.2K/48K/44.1K Hz	16/24 bits
S/PDIF In	PCM	192K/ 176.4K/96K/88.2K/48K/44.1K/32K	16/24 bits

3.3 Integrated 8051 Micro Processor

- Embedded 8051 micro-processor handles command/protocol transactions
- The MCU speed is programmable from 3.072 ~65.536 MHz
- HID interrupts can be implemented via firmware codes
- Provides maximum HW configuration flexibility with a firmware code upgrade
- VID/PID/product string can be customized via firmware code programming

3.4 Control Interface

- 1 Master I2C control interface to communicate with external devices or EEPROM, the master I2C speed supports standard mode(100KHz) and fast mode(400KHz)
- 1 Slave I2C control interface for external MCU communication, the slave I2C speed supports standard mode(100KHz) and fast mode(400KHz)
- 6 SPI master, supports speed from 32.768M ~ 0.3695Mb/s
- 24 GPIOs(programmable multi functions I/O), 8 XDs(can be GPIO or other functions)
- 6 PWM LED driver output

3.5 General

- Embedded USB 2.0 transceiver (up to 480MB bandwidth)
- Auto detection for high-speed/full-speed
- Single 12MHz crystal input is required (embedded PLL function), or optional oscillator inputs for 49.152 or 24.576MHz (for x48KHz audio format) and 45.158 or 22.5792MHz (for x44.1KHz audio format)
- 3.3V digital I/O pads with 5V tolerance
- QFN-100 package (12 x 12 mm)

3.6 Optional Value-added Software Features

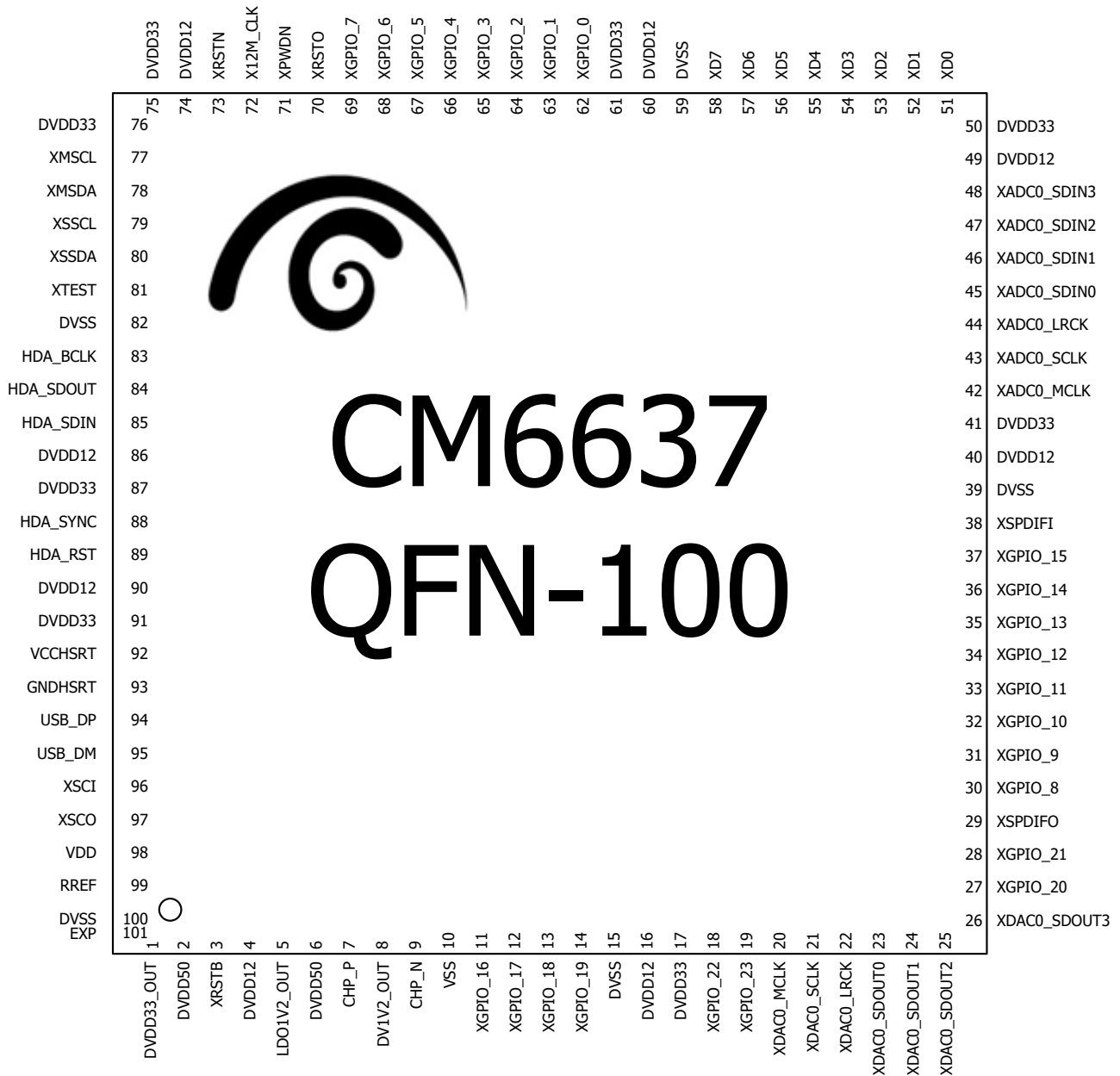
- For Windows, Cmedia drivers provide the following key features:
 - Playback feedback endpoints to control data transmission accuracy and maximize audio quality
 - Xear™ Pro- ASIO2.2 driver
 - Native DSD by ASIO

4 Applications

- USB DAC
- USB Headphone Amplifier
- Professional audio-PC musician applications (recording mixer, I/O interface, DJ console, keyboard, Electric guitar, etc.)

5 Pin Assignment

5.1 Pin-out Diagram



5.2 Pin Description

Pin #	Symbol	I/O	Description
Clock			
72	X12M_CLK	DO	12MHz clock output
96	XSCI	AI	Crystal oscillator input
97	XSCO	AO	Crystal oscillator output
USB 2.0 BUS Interface			
99	RREF	AI	USB PHY reference resistor. Connect external reference resistor (330Ω±1%)
94	USB_DP	AIO	USB 2.0 data positive
95	USB_DM	AIO	USB 2.0 data negative
Power/Ground			
1	DVDD33_OUT	PWR	LDO 3.3V Output
2	DVDD50_IN	AI	Digital supply voltage 5V for digital circuit linear regulator
4	DVDD12	PWR	Connect to V1D2_OUT for 1.2V
5	LDO1V2_OUT	PWR	LDO 1.2V output
6	DVDD50_IN	AI	Digital supply voltage 5V for DC-DC
7	CHP_P	AO	Charge-pump positive output, connected to a 2.2uF capacitor
8	D1V2_OUT	PWR	DC-DC 1.2V output
9	CHP_N	AO	Charge-pump negative output, connected to a 2.2uF capacitor
10	VSS	GND	Digital ground supply
15	DVSS	GND	Digital ground supply
16	DVDD12	PWR	Digital supply voltage 1.2V
17	DVDD33	PWR	Digital supply voltage 3.3V
39	DVSS	GND	Digital ground supply
40	DVDD12	PWR	Digital supply voltage 1.2V
41	DVDD33	PWR	Digital supply voltage 3.3V
49	DVDD12	PWR	Digital supply voltage 1.2V
50	DVDD33	PWR	Digital supply voltage 3.3V
59	DVSS	GND	Digital ground supply
60	DVDD12	PWR	Digital supply voltage 1.2V
61	DVDD33	PWR	Digital supply voltage 3.3V
74	DVDD12	PWR	Digital supply voltage 1.2V
75	DVDD33	PWR	Digital supply voltage 3.3V
76	DVDD33	PWR	Digital supply voltage 3.3V
82	DVSS	GND	Digital ground supply
86	DVDD12	PWR	Digital supply voltage 1.2V
87	DVDD33	PWR	Digital supply voltage 3.3V
90	DVDD12	PWR	Digital supply voltage 1.2V
91	DVDD33	PWR	Digital supply voltage 3.3V
92	VCCHSRT	PWR	Analog supply voltage 3.3V
93	GNDHSRT	GND	Digital ground supply
98	VDD	PWR	Digital supply voltage 1.2V, connected to the capacitor filter for digital core
100	DVSS	GND	Digital ground supply
8 Channel I2S DAC0 Interface			

20	XDAC0_MCLK	DO	1). I2S DAC0 master clock output 2). DSD bit clock output
21	XDAC0_SCLK	DIO	1). I2S DAC0 bit clock input/output 2). DSD bit clock output 3). TDM DAC SCLK Output
22	XDAC0_LRCK	DIO	1). I2S DAC0 left/right clock input/output 2). DSD channel 1 (or 0, if enable channel switching) data output 3). TDM DAC SYNC Output
23	XDAC0_SDOUT0	DO	1). I2S DAC0 serial data output for channel 0, 1 2). DSD channel 0 (or 1, if enable channel switching) data output 3). TDM DAC DATA Output
24	XDAC0_SDOUT1	DIO, PD	1). I2S DAC0 serial data output for channel 2, 3
25	XDAC0_SDOUT2	DIO, PD	1). I2S DAC0 serial data output for channel 4, 5
26	XDAC0_SDOUT3	DIO, PD	1). I2S DAC0 serial data output for channel 6, 7
8-channel I2S ADC0 Interface			
42	XADC0_MCLK	DO	I2S ADC0 master clock output
43	XADC0_SCLK	DIO	1). I2S ADC0 bit clock input/output 2). TDM ADC SCLK Output
44	XADC0_LRCK	DIO	1). I2S ADC0 left/right clock input/output 2). TDM ADC SYNC Output
45	XADC0_SDIN0	DI	1). I2S ADC0 serial data input for channel 0, 1 2). TDM ADC DATA Input
46	XADC0_SDIN1	DI	I2S ADC0 serial data input for channel 2, 3
47	XADC0_SDIN2	DI	I2S ADC0 serial data input for channel 4, 5
48	XADC0_SDIN3	DI	I2S ADC0 serial data input for channel 6, 7
S/PDIF I/O			
29	XSPDIFO	DO	S/PDIF transmitter
38	XSPDIFI	DI	S/PDIF receiver
GPIO			
11	XGPIO_16	DIO	General purpose input/output 16 (default input)
12	XGPIO_17	DIO	General purpose input/output 17 (default input)
13	XGPIO_18	DIO	General purpose input/output 18 (default input)
14	XGPIO_19	DIO	General purpose input/output 19 (default input)
18	XGPIO_22	DIO	1). General purpose input/output 22 (default input) 2). External 24.576 MHz / 49.152 MHz oscillator input
19	XGPIO_23	DIO	1). General purpose input/output 23 (default input) 2). External 22.5792 MHz / 45.1584 MHz oscillator input
27	XGPIO_20	DIO	1). General purpose input/output 20 (default input) 2). I2C Slave interrupt output to external MCU

28	XGPIO_21	DIO	1). General purpose input/output 21 (default input) 2). I2C Slave data ready indication output
30	XGPIO_8	DIO	1). General purpose input/output 8 (default output) 2). SPI Master clock output 3). I2S ADC4 master clock output
31	XGPIO_9	DIO	1). General purpose input/output 9 (default output) 2). SPI Master data output 3). I2S ADC4 bit clock input/output
32	XGPIO_10	DIO	1). General purpose input/output 10 (default input) 2). SPI Master Data input 3). I2S ADC4 left/right clock input/output 4). R8051 serial 1 interface transmit data, TXD1
33	XGPIO_11	DIO	1). General purpose input/output 11 (default input) 2). SPI Master chip enable 6 output 3). R8051 serial 1 interface receive data, RXD1 4). I2S ADC4 serial data input for channel 0, 1
34	GPIO_12	DIO	1). General purpose input/output 12 (default input) 2). I2S ADC5 master clock output 3). LED module 4 Output
35	GPIO_13	DIO	1). General purpose input/output 13 (default input) 2). I2S ADC5 bit clock input/output 3). LED module 5 Output
36	GPIO_14	DIO	1). General purpose input/output 14 (default input) 2). LED module 6 Output 3). I2S ADC5 left/right clock input/output
37	GPIO_15	DIO	1). General purpose input/output 15 (default input) 2). I2S ADC5 serial data input for channel 0, 1
51	XD0	DO	SPI Master clock output
52	XD1	DO	SPI Master data output
53	XD2	DI	SPI Master data input
54	XD3	DO	SPI Master chip enable 0 output
55	XD4	DO	SPI Master chip enable 2 output
56	XD5	DO	SPI Master chip enable 3 output
57	XD6	DO	SPI Master chip enable 4 output
58	XD7	DO	SPI Master chip enable 5 output
62	XGPIO_0	DIO	1). General purpose input/output 0 (default input) 2). I2S DAC4 master clock output

63	XGPIO_1	DIO	1). General purpose input/output 1 (default input) 2). I2S DAC4 bit clock input/output
64	XGPIO_2	DIO	1). General purpose input/output 2 (default input) 2). I2S DAC4 left/right clock input/output
65	XGPIO_3	DIO	1). General purpose input/output 3 (default input) 2). I2S DAC4 serial data output for channel 0, 1
66	XGPIO_4	DIO	1). General purpose input/output 4 (default input) 2). I2S DAC5 master clock output 3). LED module 1 Output
67	XGPIO_5	DIO	1). General purpose input/output 5 (default input) 2). I2S DAC5 bit clock input/output 3). LED module 2 Output
68	XGPIO_6	DIO	1). General purpose input/output 6 (default input) 2). I2S DAC5 left/right clock input/output 3). LED module 3 Output
69	XGPIO_7	DIO	1). General purpose input/output 7 (default input) 2). I2S DAC5 serial data output for channel 0, 1
Control Interface			
77	XMSCL	DO	I2C Master serial clock
78	XMSDA	DIO	I2C Master serial data
79	XSSCL	DIO	I2C Slave serial clock
80	XSSDA	DIO	I2C Slave serial data
Miscellaneous			
3	N.C		No connection
70	XRSTO	DO	External codec reset output (default tri-state)
71	XPWDN	DO	Power down output signal for external device output (default tri-state)
73	XRSTN	DI	Reset input, active low
81	XTEST	DI	Test mode input (Connect to ground)
83	N.C		No connection
84	N.C		No connection
85	N.C		No connection
88	N.C		No connection
89	N.C		No connection

AI: Analog Input

AO: Analog Output

AIO: Analog Input/Output

DI: Digital Input

DO: Digital Output

DIO: Digital Input/Output

6 Function Description

6.1 USB Topology

The CM6637 USB Topology is programmable by changing firmware. If the internal firmware is empty, the CM6637 will report a HID device to the system. It is used to load the firmware.

6.2 USB Endpoint

All USB devices must support a control pipe at endpoint number zero (default control pipe). The full speed and high speed devices may support up to a maximum of 16 endpoints. The endpoint table of CM6637 is listed as follows.

EndpointNumber	Direction	Type	Description
0	IN	Control	
	OUT		
1	IN	Bulk, Isochronous	Audio, Recording DMA #R5
	Out	Bulk A	
2	IN/OUT	Bulk B	
3	IN	Feedback	Audio, Playback DMA #P5
	OUT	Isochronous	
4	IN/OUT	Interrupt A	
5	IN	Feedback	Audio, Playback DMA #P0
	OUT	Isochronous	
6	IN		
	OUT		
7	IN		
	OUT		
8	IN	Isochronous	Audio, Recording DMA #R0
9	IN		
A	IN		
B	IN		
	OUT		
C	IN	Feedback	Audio, Playback DMA #P4
	OUT	Isochronous	
D	IN		
E	IN	Isochronous	Audio, Recording DMA #R4
F	IN/OUT	Interrupt B	

6.3 I2S Interface

The main audio interface of the CM6637 is I²S, which has three clock signals, MCLK, BCLK and LRCK, and at least one data line depending on the channels supported. One data line contains two channels. The three I²S clock symbols are explained below.

MCLK = main clock.

BCLK = bit clock.

LRCK = left and right clock.

6.3.1 The Basics of I2S Bus

Both master and slave modes of I2S are supported by the I2S interfaces of the CM6637, namely I2S DAC0, I2S ADC0.

Master mode means BCLK and LRCK are provided by the CM6637 as shown in Fig. 7.3.1(a). On the contrary, slave mode means BCLK and LRCK are provided by the I2S codecs as depicted in Fig. 7.3.1(b).

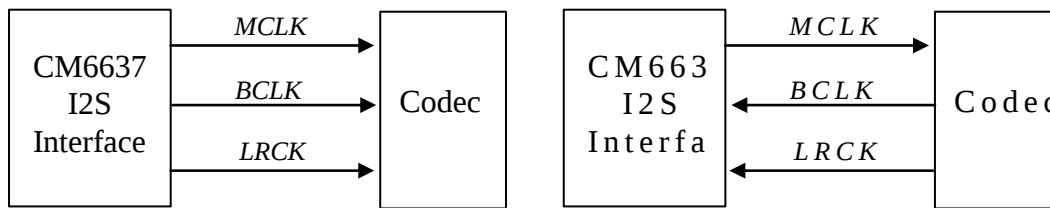


Fig. 7.3.1 (a) Master mode

Fig. 7.3.1 (b) Slave mode.

Fig. 7.3.2 indicates the basic waveform of I2S. Note that BCLK is generated at the positive edges of MCLK with the ratios 1, 1/2, 1/4, or 1/8, and LRCK is generated at the negative edges of BCLK with the ratios 1/64, 1/128, 1/256. Data bits are transited at the negative edges of BCLK, and are sampled at the positive edges of BCLK. In case of playback, CM6637 is the data transmitter and the codec is the data receiver. As for recording, the roles of CM6637 and codec are reversed.

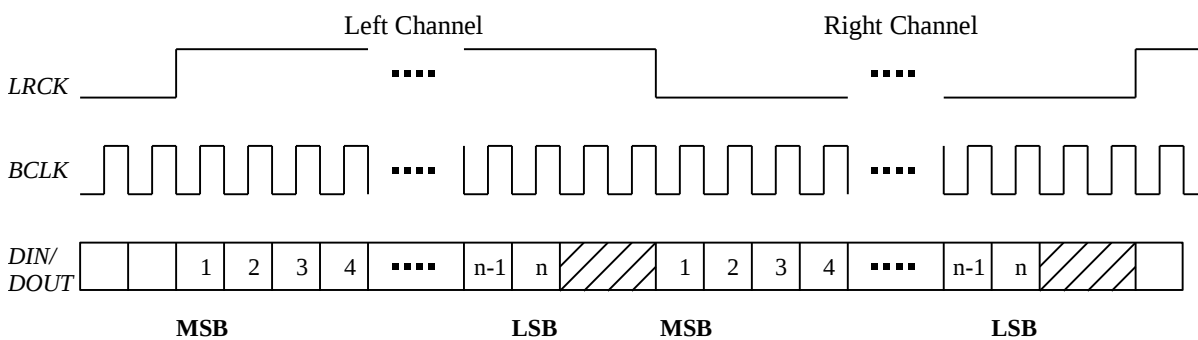


Fig. 7.3.2 The basic timing diagram of the I2S interface.

For the I2S DAC controller, the audio data is transformed from the parallel format to the serial format before transmitted. Then, the bit data is shifted out one by one with the MSB first via DOUT signal. If the I2S DAC controller is set to 32 bits, at least 32 BCLK clocks must exist in both LRCK left and right channels. In the same manner, the audio data is transformed from the coming serial format to the parallel format for a I2S ADC controller.

6.3.2 Left Justified Mode

In the left justified mode of the I2S DAC controller, the MSB data bit is clocked out by the CM6637 at the negative edge of BCLK which is aligned to the transition of LRCK. In the left justified mode of I2S ADC controllers, the MSB data bit is clocked out by codecs and sampled by the CM6637 at the first positive edge of BCLK which follows a LRCK transition. LRCK is high during left channel transmission and low during right channel transmission in the left justified mode. Fig. 7.3.2 shows all of these.

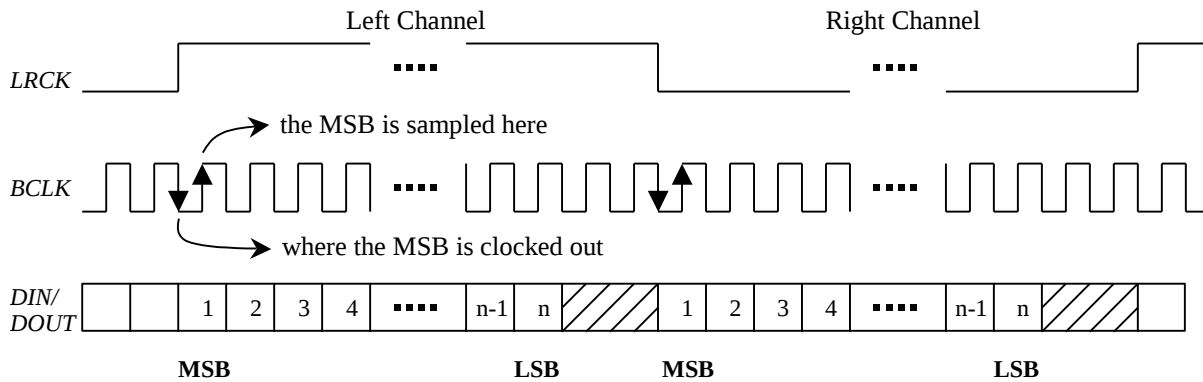


Fig. 7.3.2 Left justified mode timing diagram of I2S interface.

6.3.3 I2S Mode

In the I2S mode of the I2S DAC controller, the MSB data bit is clocked out by CM6637 at the first negative edge of BCLK which follows a LRCK transition. In the I2S mode of I2S ADC controllers, the MSB data bit is clocked out by codecs and sampled by the CMA6635 at the second positive edge of BCLK which follows a LRCK transition. LRCK is low during left channel transmission and high during right channel transmission in the I2S mode. Fig. 7.3.3 indicates all of these.

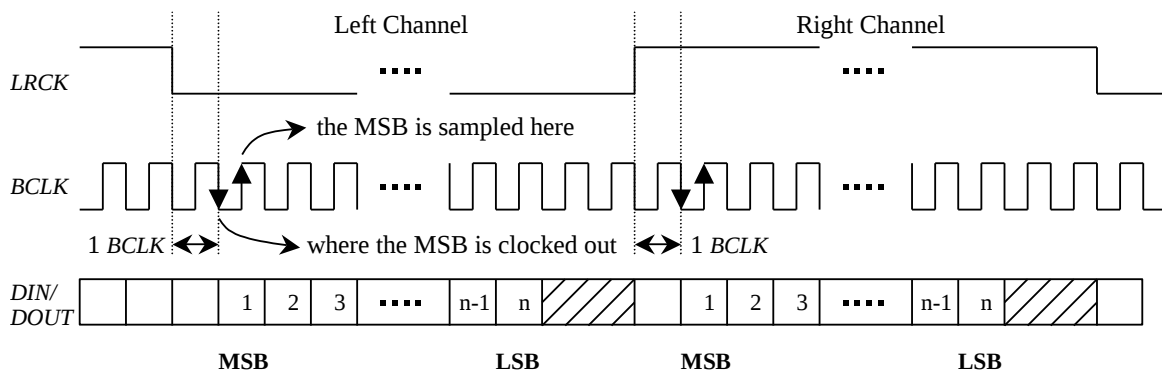


Fig. 7.3.3 I2S mode timing diagram of I2S interface.

6.4 S/PDIF Interface

SPDIF is an audio transmission format in digital domain. The data stream format is illustrated in Fig. 7.4.1. The maximum unit of the S/PDIF stream is a block. A block is composed of 192 frames, and each frame is composed of two subframes. One frame contains one audio sample, so the frame rate is equal to the sampling rate. The left channel audio data is carried by bit slot 4-27 (or time slot 4-27) of subframe A, and right channel is carried by bit slot 4-27 of subframe B. The Sync slot takes preamble signal which is used to label the beginning of a subframe. There are three types for preamble signal, the first is B type, used only in the first subframe of a block; the W type, used in all subframe B; the M format, used in all subframe A, besides the first subframe of a block. The block format is shown in Fig. 7.4.1. The logical level at the start of a bit is always inverted to the level at the end of the previous bit. The level at the end of a bit is equal (a 0 transmitted) or inverted (a 1 transmitted) to the start of that bit.

The S/PDIF data signal is coded by the “biphase-mark-code,” which is a kind of phase modulation. It is illustrated in Fig. 7.4.2. The base clock of a S/PDIF signal is twice the bit rate, and the frequency of the base clock is only

determined by the sampling rate. The period of the base clock is called the Unit interval (UI). For example, for a 48KHz 2-channel S/PDIF signal, the frame rate is also 48KHz, so a frame period is 20.833us, and a subframe period is 10.416us. A subframe contains 32-bit slot, so a bit slot period is 325.52ns. As we said above, the base clock is twice the bit rate. Therefore, the period of the base clock is 162.76ns. In other words, the frequency of base clock is 6.144 MHz. Bi-phase coding can prevent PCM data from DC isolated and insensitive to level polarity. A maximum up to 24 data bits can be transmitted by the S/PDIF signal, and the sequence is from LSB to MSB.

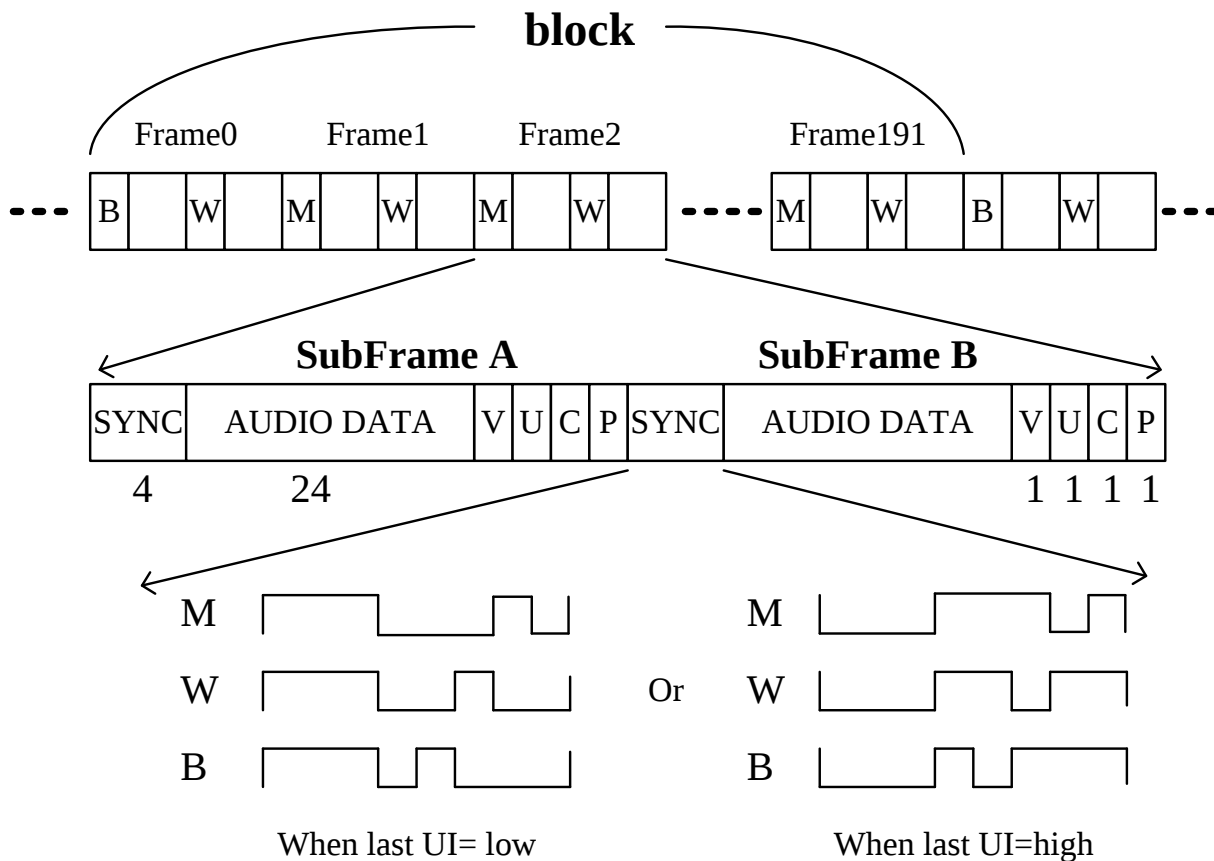


Fig. 7.4.1 S/PDIF Frame format.

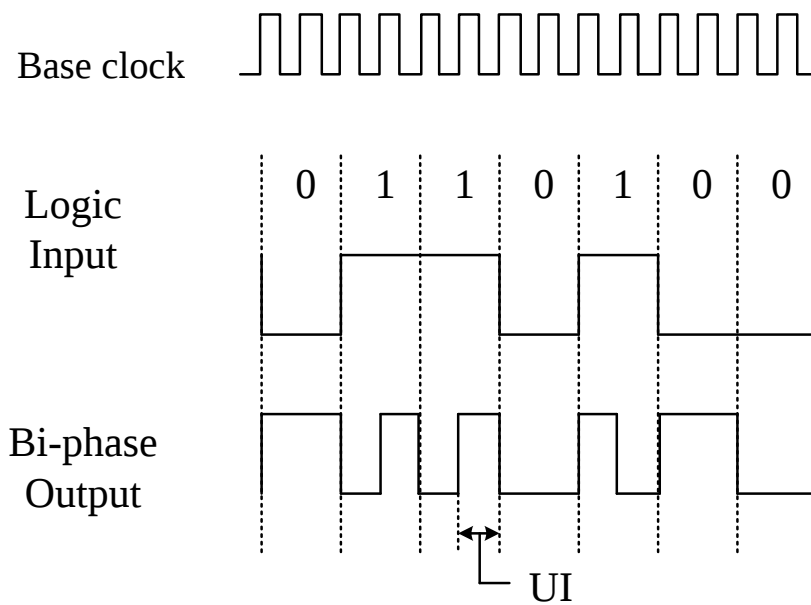


Fig. 7.4.2 S/PDIF biphasic-mark-code (BMC).

6.5 I2C, Two-Wire Interface

The 2-wire master and slave serial buses are designed separately in the CM6637. There are two reasons which let us make such a decision. The first reason is that the separated 2-wire master and slave buses are easier to design, and the second reason is that the 2-wire master bus pins have been shared with SPI interface. In the most applications, the SPI interface is the one that is chosen to control the codecs, so the 2-wire slave bus cannot combine with the 2-wire master bus.

6.5.1 The Concept of I2C, Two Wire Interface

The 2-wire bus, as its name reveals, has 2 lines. One is the serial clock line (*SCL*), and the other is the serial data line (*SDA*). Both of them are operated under open drain. That means if the 2 lines are not driven by a master or a slave, they are pulled high by the external pull-up resistors as indicated by Fig. 7.5.1. A device connected on the bus can be recognized as a master or a slave when performing data transfers. A master is the device which initiates a data transfer on the bus and generates the clock signals to permit that transfer. At that time, any device addressed is considered a slave. Another concept that we should know is the transmitter-receiver relation. *The transmitter is the device which sends data to the bus, and receiver is the device which receives data from the bus.* Note that the definition of transmitter-receiver is different from that of master-slave. We will use these terms to explain 2-wire read/write transactions later. The CM6637 use 7 bits to address the slave devices such as codecs, so theoretically, the 2-wire bus is able to connect 128 slave devices. However, in the audio system application, the limitation is on the codecs, not on the CM6637. Usually, the codecs which support 2-wire bus only have one or two pins to select their address. Therefore, two or four codecs is allowed in the system indicated by Fig. 7.5.1, unless the codecs are from different manufactures. In the MCU application, the CM6637 is a slave device, and it can be addressed by the MCU via four different addresses, 0001000b, 0001001b, 0001010b, 0001011b.

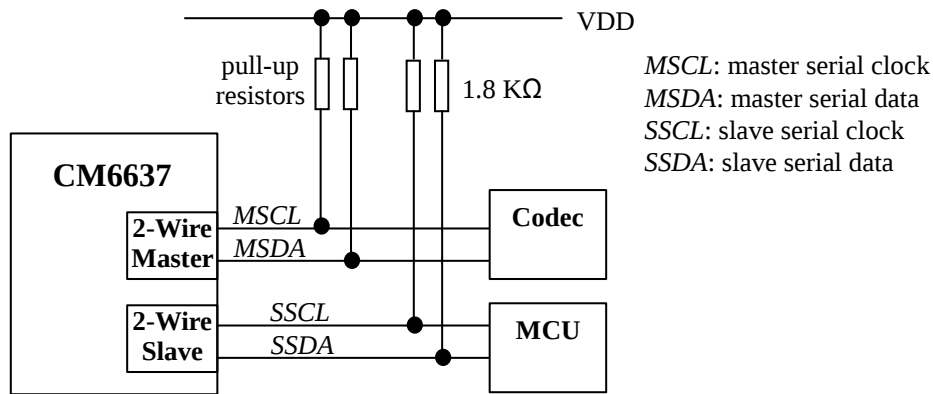


Fig. 7.5.1 The connection of 2-wire master and slave buses.

6.5.2 Start and Stop Condition

For a 2-wire bus transaction, the start and stop condition is defined as follows and shown in Fig.7.5.2.

- Start: a high to low transition on the *SDA* line while *SCL* is high.
- Stop: a low to high transition on the *SDA* line while *SCL* is high.

Start and stop conditions always generated by the master device. The bus is considered to be busy after the start condition. The bus is considered to be free again after the stop condition.

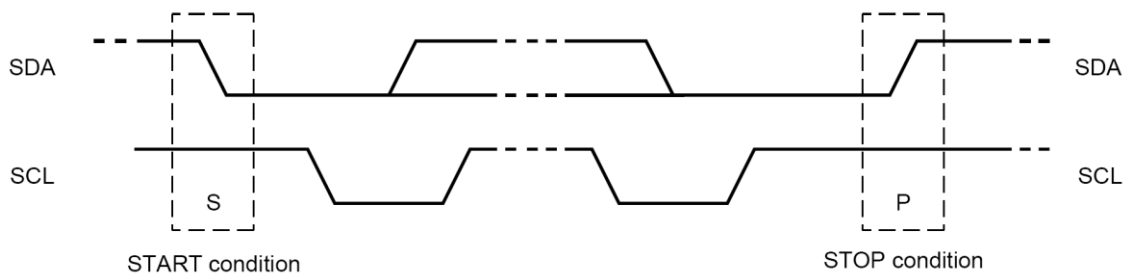


Fig. 7.5.2 Start and stop conditions of 2-wire bus.

6.5.3 Bit Transfer

The data on the *SDA* line must be stable during the high period of the clock. The state of the data line can only transit when the clock signal on *SCL* line is low. The bit transfer is indicated in Fig. 7.5.3.

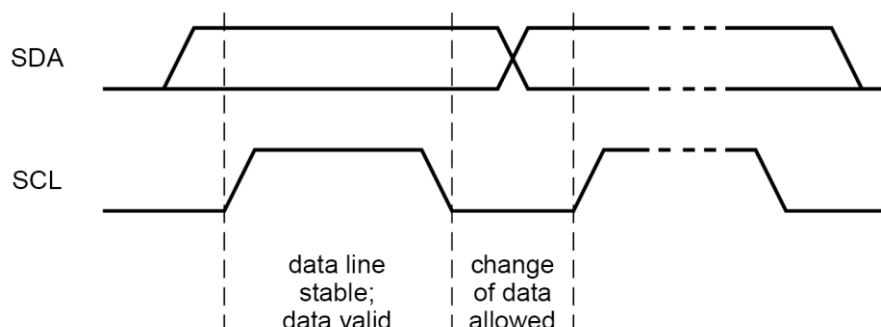


Fig. 7.5.3 Bit transfer of 2-wire bus.

6.5.4 Transferring Data with Read/Write Transactions and Acknowledge

Every byte put on the SDA line must be 8-bit long. The number of bytes that can be transmitted per transfer is 3 or 4 bytes in the CM6637. The first byte is always the address byte which is composed of the 7-bit address and 1 read/write bit, listed in Fig. 7.5.4.1 For a write transaction, the second byte is called *Memory Address Pointer (MAP)*, which is usually used to indicate the target register in the slave device that the followed third and fourth bytes will be applied on. For a read transaction (only 3 bytes), the second and third bytes is the data returned by the slave device. Each byte has to be ended by an acknowledge bit. Data is transferred with the most significant bit first.

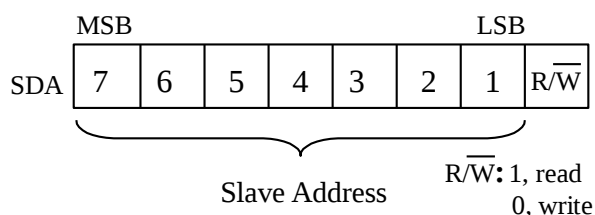


Fig. 7.5.4.1 The first byte after start condition.

The 2-wire master bus of the CM6637 supports read/write transactions. All these transactions are depicted in Fig. 7.5.4.2 to give a whole picture about what the CM6637 can do.

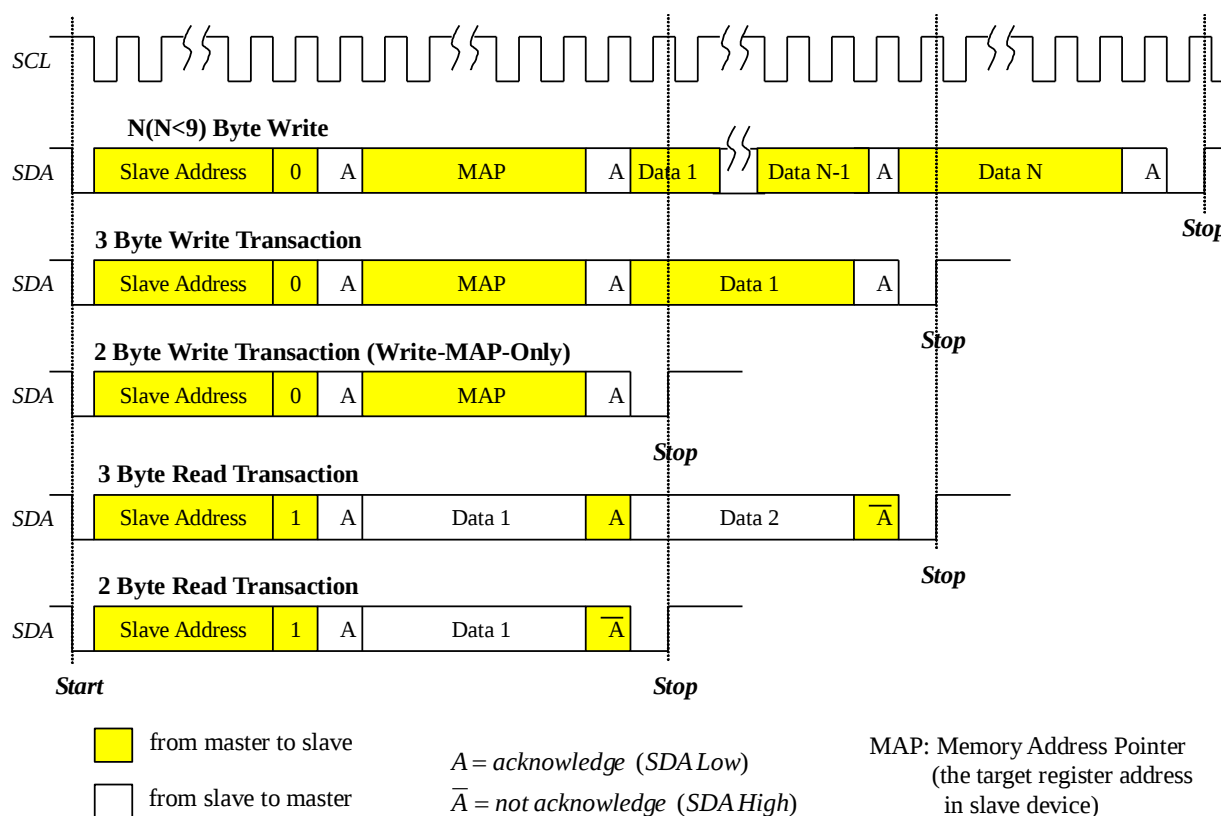


Fig. 7.5.4.2 The 5 basic transactions of the 2-wire master bus supported by the CM6637.

In a read transaction, usually the slave device returns the data of the register whose address is in the MAP. If the read transaction is a 3 byte read transaction, the second returned byte is the data in the (address+1) register. Therefore, the action of obtaining the data in slave device is composed of two transactions, namely a 2 byte write transaction (Write-MAP-Only) followed by a read transaction. For the convenience of users, we have designed an auto read transaction, shown in Fig. 7.5.4.3, which is actually the combination of a write and a read transactions.

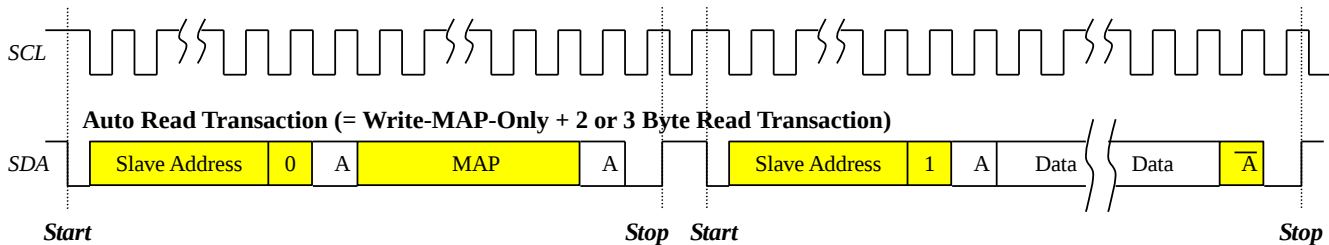


Fig. 7.5.4.3 Auto read transaction in the CM6637.

Data transfer with acknowledge is obligatory. The transmitter release SDA line during the acknowledge clock pulse. Then, the receiver must pull down the SDA line during the acknowledge clock pulse so that it remains low for the entire acknowledge clock high period. This is shown in Fig. 7.5.4.4. When a slave does not acknowledge the slave address byte. For example, it is unable to receive or transmit because it is performing some real-time function. The data line should be left high by the slave. The master can then generate either a stop condition to abort the transfer, or a repeated start condition to start a new transfer.

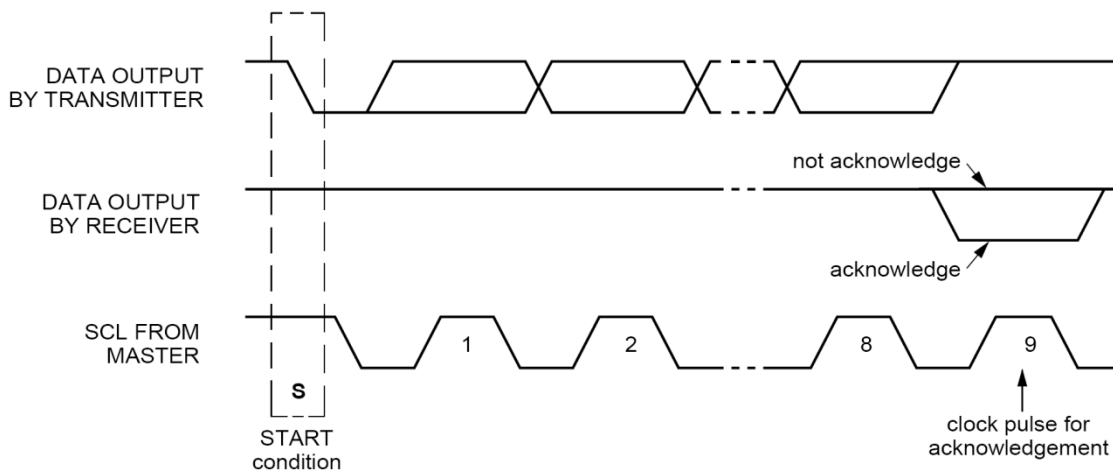


Fig. 7.5.4.4 Acknowledge of the 2-wire bus.

For a read transaction, after the slave address byte is transmitted and acknowledged by slave device, the role of master-transmitter is altered to become master-receiver, and the original slave-receiver is altered to become slave-transmitter. This conception can be easily observed in Fig. 7.5.4.3 and 7.5.4.4, where we use yellow and white blocks to denote the data bit transfer direction. Yellow means the data direction is from the master to the slave. White means the data direction is from the slave to the master. Meanwhile, in a read transaction, the master-receiver must signal the end of the data to the slave transmitter by generating a not-acknowledge ($\bar{A}$) on the last byte that was clocked out of the slave-transmitter. The slave-transmitter should release the SDA line to allow the

master to generate a stop or repeated start condition.

6.5.5 Synchronization

The synchronization of the 2-wire bus in the CM6637 can be described in two aspects. The first aspect is the synchronization used in arbitration. Although we did not implement arbitration, we did implement clock synchronization. Clock synchronization is used when there are more than two masters connected on the bus. A high to low transition on the *SCL* line will cause the concerned masters start counting the clock low period. Before the clock high state is reached, the masters will hold the *SCL* line in low state. However, the low to high clock transition of one of the masters may not change the state of the *SCL* line if another master's clock is still in low period (because the *SCL* line of the devices are wire-AND connected by open-drain technique). Therefore, the *SCL* line will be held low by the device with the longest clock low period. The other devices with shorter low period, including the CM6637, enter a high wait state during this time. Figure 7.5.5.1 listed below is the timing of clock synchronization.

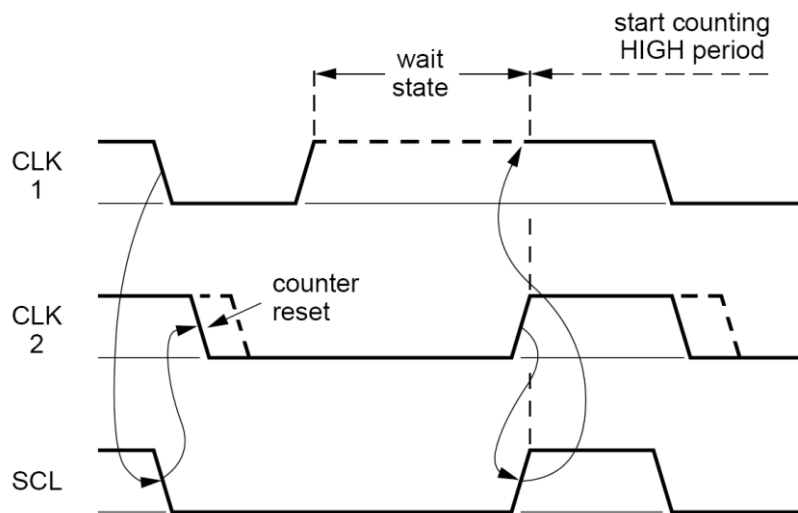


Fig. 7.5.5.1 Clock synchronization for more than two masters in the bus.

Another aspect of synchronization is the data synchronization between master and slave. If a slave cannot receive or transmit another complete byte of the data until it has performed some other function, for example servicing an internal interrupt or waiting for the driver to prepare the data needed, the slave can hold the clock line *SCL* low to force the master into a wait state. Data transfer then continues when the slave is ready and releases the clock line *SCL*. The data synchronization is shown in Fig. 7.5.5.2.

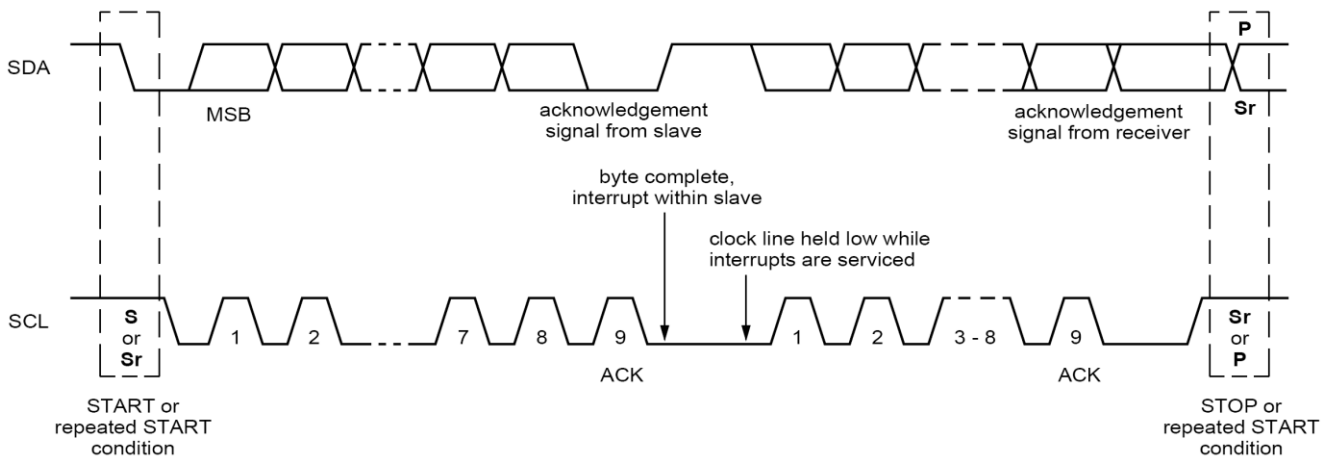


Fig. 7.5.5.2 The data synchronization of the 2-wire master and slave buses in the CM6637.

6.5.6 Standard Mode and Fast Mode

Both the 2-wire master and slave buses in the CM6637 can support standard mode transfer and fast mode transfer. The data transfer rate of the standard mode is up to 100 Kbits/sec, and the fast mode is up to 400 Kbits/sec. The clock timing of these modes are listed in Fig. 7.5.6 and Table 7.5.6

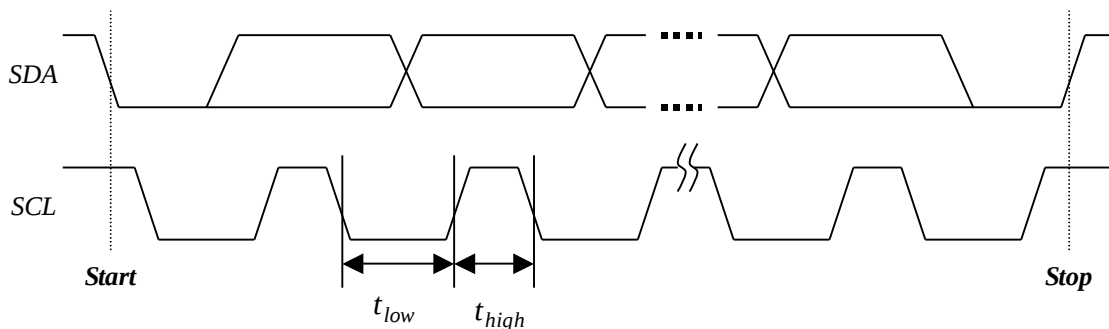


Fig. 7.5.6.1 Standard mode and fast mode timing.

Table 7.5.6 Standard mode and fast mode timing.

Parameter	Symbol	Standard mode		Fast mode		Unit
		MIN	MAX	MIN	MAX	
SCL clock frequency	f_{SCL}	0	100	0	400	KHz
Low period of SCL clock	t_{low}	4.8	—	1.3	—	μS
High period of SCL clock	t_{high}	4.8	—	0.6	—	μS

6.6 TDM(Time-Division Multiplexing)

There are two TDM interfaces in CM6637. One is TDM-out and another is TDM-in. TDM has two clock signals and one data signal used to transmit 8-channel data. Supported audio data format are Mode 1 and Mode 2.

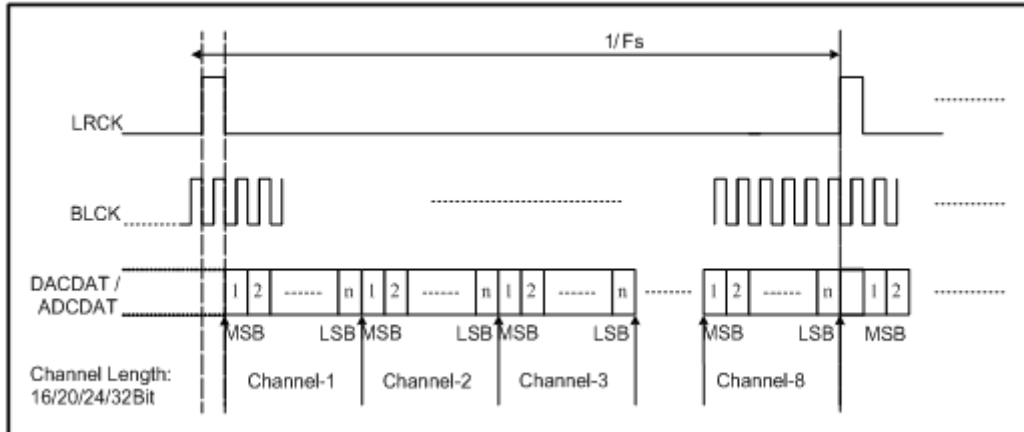


Fig. 7.6.1 TDM Mode 1 (BCLK POLARITY=0)

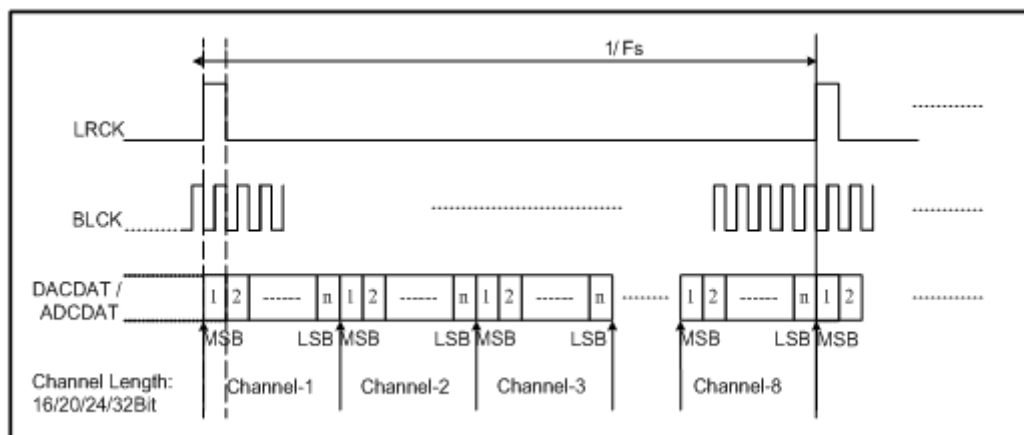


Fig. 7.6.2 TDM Mode 2 (BCLK POLARITY=0)

7 Electrical Characteristics

7.1 Absolute Maximum Ratings

Parameter	Symbol	Min.	Typ	Max.	Unit
Storage temperature	T_s	-40	-	125	°C
supply voltage	DVDD50_IN	-	-	5.5	V
ESD (Body mode)	HBM	-	±4000	-	V
ESD (Machine mode)	MM	-	±200	-	V

7.2 Recommended Operation Conditions

Parameter	Symbol	Min.	Typ	Max.	Unit
Operating ambient temperature	T_A	0	25	70	°C
supply voltage	DVDD50_IN	4.5	5	5.5	V
Crystal Clock	-		12.000		MHz

7.3 Static Characteristics

Parameter		Min.	Typ	Max.	Units
Input voltage range	DI	0		5.5	V
Output voltage range	DO	0		3.3	V
Input Voltage High	VIH	0.7*DVDD33	DVDD33	5.5	V
Input Voltage Low	VIL	-	-	0.3*DVDD33	V
Output Voltage High	VOH	0.9*DVDD33	-	-	V
Output Voltage Low	VOL	-	-	0.1*DVDD33	V

7.4 Power Consumption

Test Conditions: DVDD50_IN, DVSS =0V, TA=+25°C, MCU Clock = 3MHz.

Sample Rate=48kHz, 24Bits, Operation: I2S output and I2S input,

I2S output and I2S input = Gain 0dB

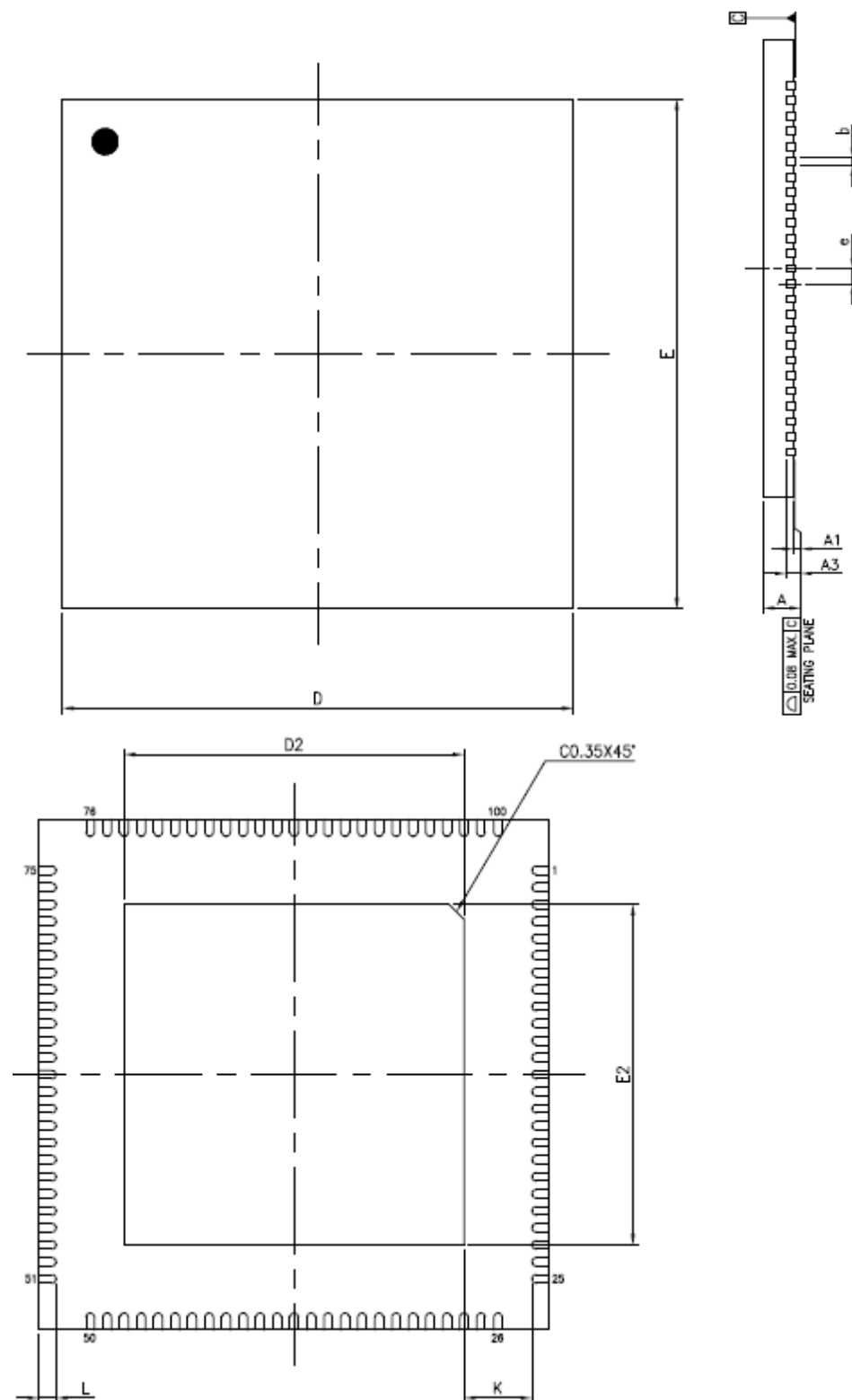
Parameter	Min.	Typ	Max.	Units
Total power consumption (Playback + Record)	-	48	-	mA
Standby power consumption	-	41.6	-	mA
Suspend mode power consumption	-	2.3	-	mA

7.5 DC Characteristics

Test Conditions: DVDD50_IN=5V, DVSS =0V, TA=+25°C

Parameter	Symbol	Min.	Typ	Max.	Units
High-level input voltage	Vih	2.4	-	5.3	V
Low-level input voltage	Vil	-	-	0.8	V
High-level output voltage	Voh	2.4	-	-	V
Low-level output voltage	Vol	-	-	0.4	V
SPDIF High-level input voltage	-	1.75	-	-	V
SPDIF Low-level input voltage	-	-	-	1.55	V

8 Package Dimensions



JEDEC OUTLINE	MO-220		
PKG CODE	VQFN(YCA0)		
SYMBOLS	MIN.	NOM.	MAX.
A	0.80	0.85	0.90
A1	0.00	0.02	0.05
A3	0.203 REF.		
D	12.00 BSC		
E	12.00 BSC		
b	0.15	0.20	0.25
e	0.40 BSC		
L	0.35	0.40	0.45
K	0.20	—	—

PAD SIZE	D2			E2			LEAD FINI	
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	Pure Tin	PF
323X32* MIL	7.95	8.00	8.05	7.95	8.00	8.05	✓	✓

NOTES :

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15mm AND 0.30mm FROM THE TERMINAL TIP. IF THE TERMINAL HAS THE OPTIONAL RADIUS ON THE OTHER END OF THE TERMINAL, THE DIMENSION b SHOULD NOT BE MEASURED IN THAT RADIUS AREA.
3. BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

— End of Datasheet —

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